

SURFACE MOUNT BI-DIRECTIONAL THYRISTOR SURGE PROTECTOR DEVICE

FEATURES

- Protects by limiting voltages and shunting surge currents away from sensitive circuits
- Designed for telecommunications applications such as line cards, modems, PBX, FAX, LAN, VHDLSL
- Helps meet standards such as GR1089, ITU K.20, IEC950, UL1459&50, FCC part 68
- Low capacitance, High surge (A, B, C rating available), precise voltage limiting, Long life



SUMMARY ELECTRICAL CHARACTERISTICS

Part Number	Rated Repetitive Peak Off-State Voltage	Breakover Voltage	On-State Voltage	Repetitive Peak Off-State Current	Breakover Current	Holding Current	Off-State Capacitance (f = 1 MHz, Vac = 15 mV _{RMS})			
	Max.	Max.	Max.	Max.	Max.	Min.	Typ.	Max.	Typ.	Max.
	V _{DRM}	V _{BO @ I_{BO}}	V _{T @ 1A}	I _{DRM}	I _{BO}	I _H	C _{O @ 0 V_{dc}}		C _{O @ 50 V_{dc}}	
	V	V	V	μA	mA	mA	pF		pF	
TSP058SC	58	77	5	5	800	150	85	105	35	43
TSP065SC	65	88	5	5	800	150	80	101	34	40
TSP075SC	75	98	5	5	800	150	78	95	30	37
TSP090SC	90	130	5	5	800	150	70	80	23	34
TSP120SC	120	160	5	5	800	150	63	79	20	29
TSP140SC	140	180	5	5	800	150	61	78	19	28
TSP160SC	160	220	5	5	800	150	58	75	19	27
TSP190SC	190	260	5	5	800	150	57	71	19	26
TSP220SC	220	300	5	5	800	150	57	71	18	26
TSP275SC	275	350	5	5	800	150	56	70	18	25
TSP320SC	320	400	5	5	800	150	56	70	17	24
Notes	(1,3)	(3,5,6)	(3)	(3)	(3)	(2,3)	(3)	(3)	(3)	(3)

NOTES:

1. Specific V_{DRM} values are available by request.
2. Specific I_H values are available by request.
3. All ratings and characteristics are at 25 °C unless otherwise specified.
4. V_{DRM} applies for the life of the device. I_{DRM} will be in spec during and following operation of the device.
5. V_{BO1} is at 100V/msec, I_{SC} = 10A_{pk}, V_{OC} = 1KV_{pk}, 10/1000 Waveform
6. V_{BO2} is at f = 60 Hz, I_{SC} = 1 A_(RMS), Vac = 1KV_(RMS), R_L = 1 KΩ, 1/2 AC cycle

SELECTION GUIDE

Follow these steps to select the proper Thyristor surge protector for your application:

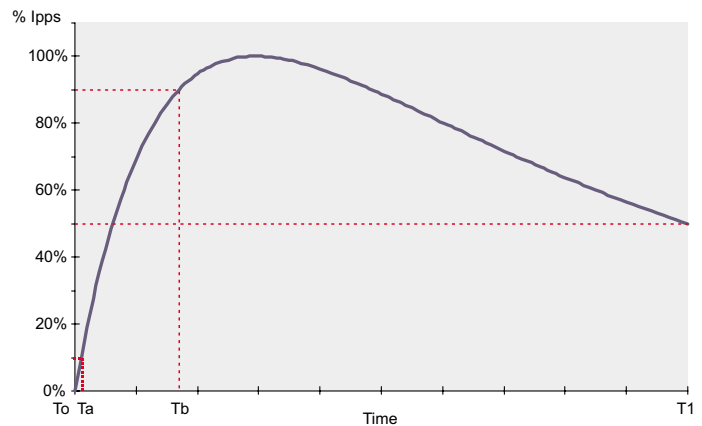
- Define the operating parameters for the circuit:
 - Ambient operating temperature range
 - Maximum telephone line operating current (highest battery and shortest copper loop)
 - Maximum operating voltage: (Maximum DC bias + peak ringing voltage)
 - Maximum surge current
 - System voltage damage threshold
 - Select device with an off-state voltage rating (V_{DRM}) above the maximum operating voltage at the minimum operating temperature.
- Select surge current ratings (I_{PPS} and I_{TSM}) \geq those which the application must withstand.
- Verify that the minimum holding current of the device at the maximum ambient temperature is above the maximum dc current of the system.
- Verify that the maximum breakover voltage of the device is below the system damage threshold.
- Verify that the circuit's ambient operating temperatures are within the device's operating temperature range.
- Verify that the device's dimensions fit the application's space considerations.
- Independently evaluate and test the suitability and performance of the device in the application

MAXIMUM SURGE RATINGS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Rating	Non-Repetitive Peak Pulse Current						Non-Repetitive Peak On-State Surge Current
Symbol	I_{PPS}						I_{TSM}
Short-Circuit Current Wave	2/10 μs	8/20 μs	10/160 μs	5/310 μs	10/560 μs	10/1000 μs	60A
Open-Circuit Voltage Wave	2/10 μs	1.2/50 μs	10/160 μs	10/700 μs	10/560 μs	10/1000 μs	
Value	500 A	350 A	200 A	150 A	125 A	100 A	
Notes	(1,2,4,5,6)						(1,2,3,4)

Notes:

- Thermal accumulation between successive surge tests is not allowed.
- The device under test initially must be in thermal equilibrium with $T_J = 25^\circ\text{C}$.
- Test at 1 cycle, 60 Hz.
- Surge ratings are non-repetitive because instantaneous junction temperatures may exceed the maximum rated T_J . Nevertheless, devices will survive many surge applications without degradation. Surge capability will not degrade over a device's typical operating life.
- Adjust the surge generator for optimum current-wave accuracy when both voltage and current wave specifications cannot be exactly met. The current wave is more important than the voltage wave for accurate surge evaluation.
- The waveform is defined as A/B ms where:
 - A: (Virtual front time) = $1.25 \times \text{Rise time} = 1.25 \times (T_b - T_a)$
 - B: (Duration time to 50% level of I_{pps}) = $T_1 - T_0$



MAXIMUM THERMAL RATINGS

Rating	Symbol	Value	Unit
Storage Junction Temperature Range	T _{STG}	-50 to 150	°C
Operating Junction Temperature Range	T _J	-40 to 150	°C
Operating Ambient Temperature Range	T _a	-40 to 65	°C

Notes:

PCB board mounted on minimum foot print.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Leads T _L on tab adjacent to plastic. Both leads soldered to identical pad sizes.	R _{θJL}	Max. 20	°C / W

Notes:

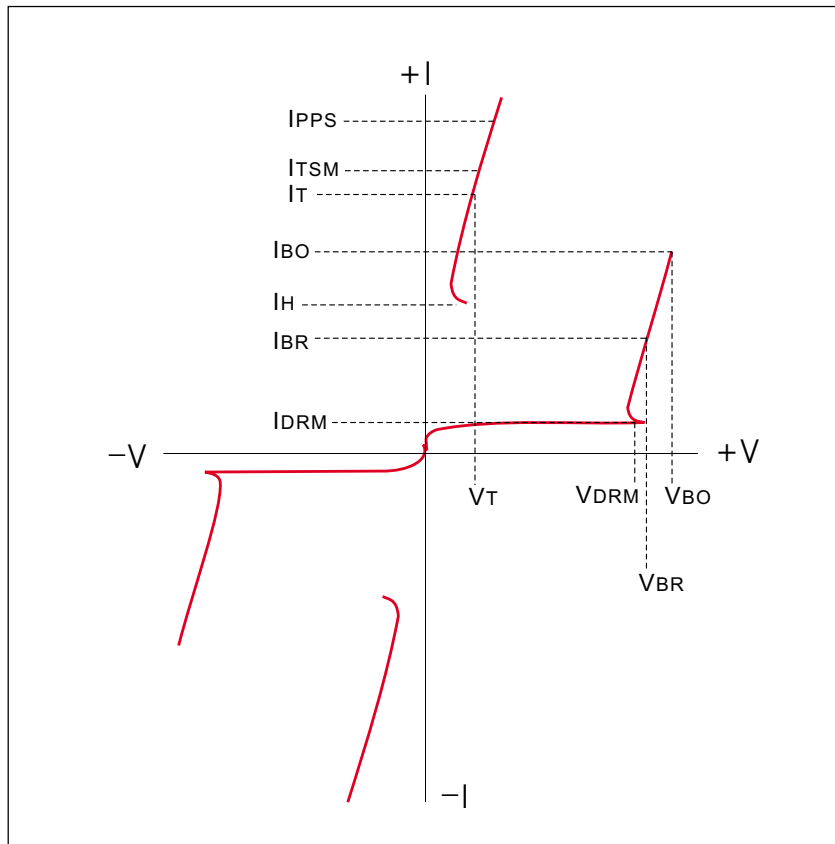
The junction to lead thermal resistance represents a minimum limiting value with both leads soldered to a large near-infinite heatsink. The junction to ambient thermal resistance depends strongly on board mounting conditions and typically is 3 to 6 times higher than the junction to lead resistance. The data shown is to be used as guideline values for preliminary engineering.

ELECTRICAL CHARACTERISTICS (T_c = 25°C UNLESS OTHERWISE NOTED)

Parameters	Test Conditions	Symbol	Min.	Max.	Unit
Repetitive Peak Off-State Current	V _D = rated V _{DRM}	I _{DRM}		5	μA
Breakover Current	f = 60 Hz, I _{sc} = 1 Arms, V _{ac} = 1 KVrms, R _L = 1 KΩ, 1/2 AC cycle	I _{BO}		800	mA
Holding Current1	10/1000μs waveform, I _{sc} = 10A, V _{oc} = 62 V, R _L = 400 Ω	I _H	150		mA
On-State Voltage	I _T = 1 A, T _w = 300 μs, 1 pulse	V _T		5	V

Notes:

Specific I_H values are available by request.



Characteristic	Symbol	Value
V_{BO}	Breakover Voltage	Maximum voltage across the device in or at breakdown measured under a specified voltage and current rate of rise
I_{BO}	Breakover Current	Instantaneous current flowing at the breakover voltage (V_{BO})
I_H	Holding Current	Minimum current required to maintain the device in the on-state
I_T	On-state current	Current through the device in the on-state condition
V_T	On-state voltage	Voltage across the device in the on-state condition at a specified current (I_T)
V_{DRM}	Rated Repetitive Peak Off-State Voltage	The highest instantaneous value of the off-state voltage, including all repetitive transient voltages but excluding all nonrepetitive transient voltages
I_{DRM}	Repetitive Peak Off-State Current	The maximum (peak) value of current that results from the application of V_{DRM}
I_{PPS}	Non-Repetitive Peak pulse current	Rated maximum value of peak impulse current of specified amplitude and waveshape that may be applied without damage to the device under test
di/dt	Critical rate of rise of on-state current	Rated value of the rate of rise of current that the device can withstand without damage.
dv/dt	Critical Rate of Rise of Off-State Voltage	The maximum rate of rise of voltage (below V_{DRM}) that will not cause switching from the off-state to the on-state.

CAPACITANCE CHARACTERISTICS

F = 1 MHz, V_{ac} = 15 mV_{rms}

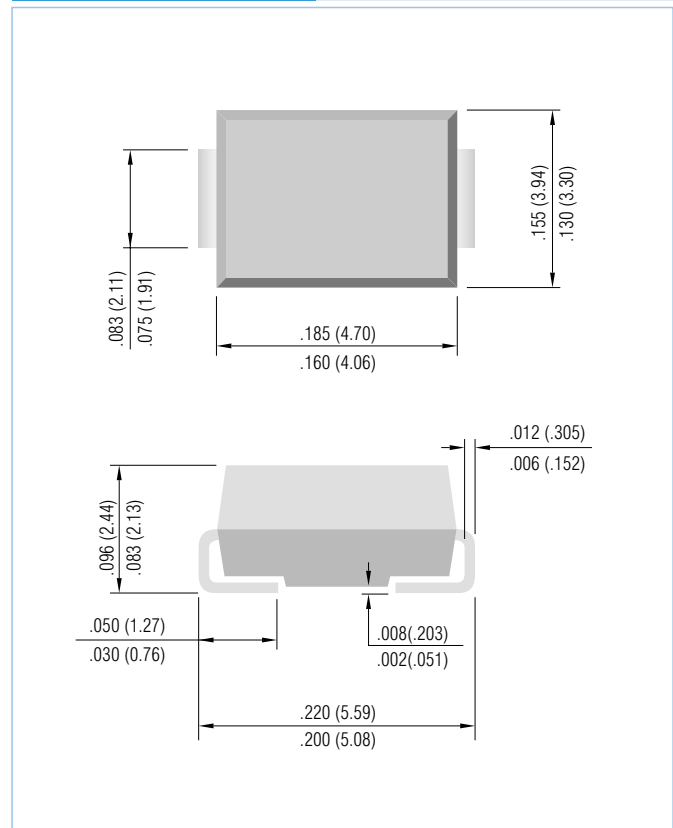
Part Number	Off-State Capacitance C _o									
	pF									
	0 Vdc		1 Vdc		2 Vdc		5 Vdc		50 Vdc	
	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.
TSP058SC	85	105	75	90	69	83	60	70	35	43
TSP065SC	80	101	71	86	65	79	56	66	34	40
TSP075SC	78	95	65	80	59	73	50	60	30	37
TSP090SC	70	80	58	66	52	57	43	50	23	34
TSP120SC	63	79	52	60	47	58	39	45	20	29
TSP140SC	61	78	50	58	45	56	36	44	19	28
TSP160SC	58	75	48	56	43	53	34	43	19	27
TSP190SC	57	71	47	55	42	49	33	42	19	26
TSP220SC	57	71	47	55	42	49	33	42	18	26
TSP275SC	56	70	46	55	42	49	32	42	18	25
TSP320SC	56	70	46	55	41	49	32	42	17	24

MECHANICAL DATA

- Case: JEDEC DO-214AA molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Bi-directional Standard packaging: 12mm tape (EIA-481)
- Weight: 0.003 ounce, 0.093 gram

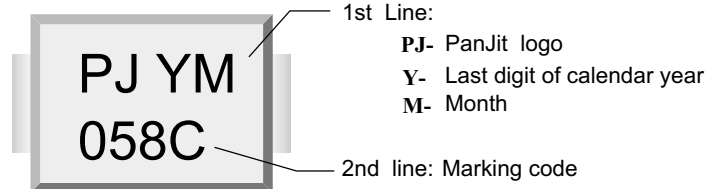
SMB / DO-214AA

Unit: inch (mm)



DEVICE MARKING CODE

Part Number	Marking Code
TSP058SC	058C
TSP065SC	065C
TSP075SC	075C
TSP090SC	090C
TSP120SC	120C
TSP140SC	140C
TSP160SC	160C
TSP190SC	190C
TSP220SC	220C
TSP275SC	275C
TSP320SC	320C

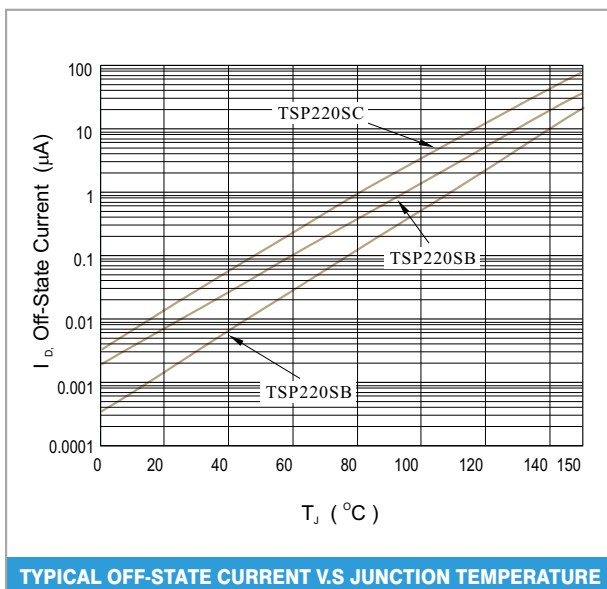
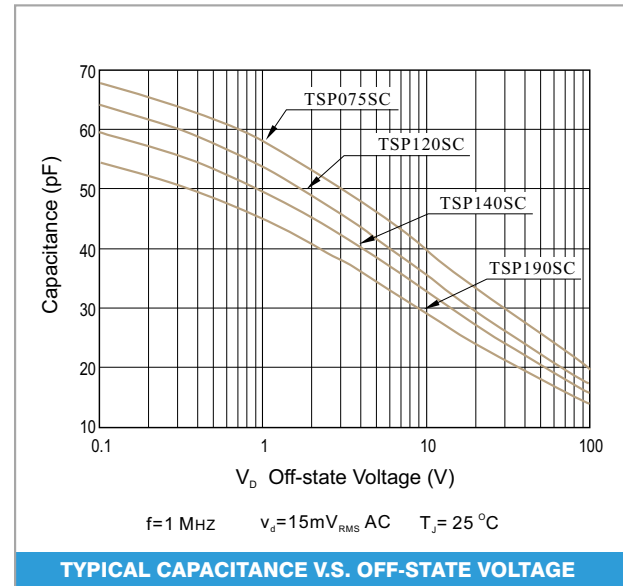
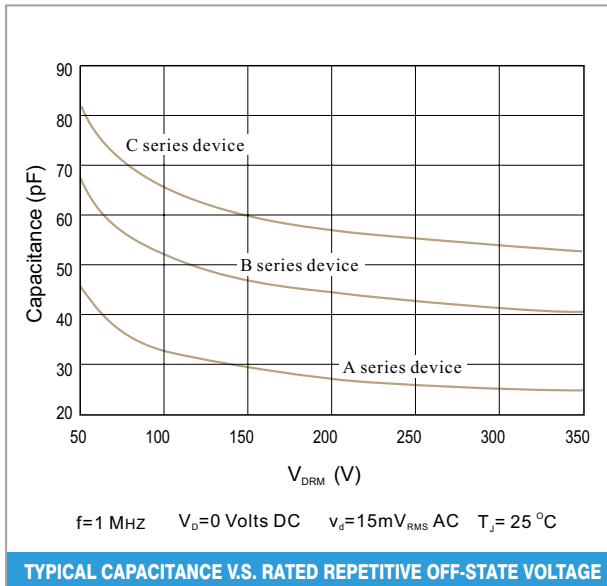


THYRISTOR | TSP058SC - TSP320SC |

ORDER & PACKING INFORMATION

Device	Packing	Min. Order Q'ty	Order As	Remark
TSPxxxSC	13" Tape & Reel	3,000 pcs	TSPxxxSC	Standard Packing
	7" Tape & Reel	500 pcs	TSPxxxSC-7	

RATING AND CHARACTERISTIC CURVES



IMPORTANT NOTICE

This information is intended to unambiguously characterize the product in order to facilitate the customer's evaluation of the device in the application. It will help the customer's technical experts determine that the device is compatible and interchangeable with similar devices made by other vendors. The information in this data sheet is believed to be reliable and accurate. The specifications and information herein are subject to change without notice. New products and improvements in products and their characterization are constantly in process. This provides a superior performing and the highest value product. The factory should be consulted for the most recent information and for any special characteristics not described or specified.

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